

TLVH431B-Q1 SLVS906B-DECEMBER 2008-REVISED MARCH 2011

I ANODE

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TLVH431A-Q1

LOW-VOLTAGE ADJUSTABLE PRECISION SHUNT REGULATORS

Check for Samples: TLVH431A-Q1, TLVH431B-Q1

FEATURES

- **Qualified for Automotive Applications**
- Low-Voltage Operation: Down to 1.24 V
- Reference Voltage Tolerances at 25°C
 - 0.5% for B Grade
 - 1% for A Grade
- Adjustable Output Voltage, $V_0 = V_{REF}$ to 18 V
- Wide Operating Cathode Current Range: 100 µA to 70 mA
- **0.25-**Ω Typical Output Impedance
- -40°C to 125°C Specifications



Pin 2 is attached to Substrate and must be connected to ANODE or left open.

DESCRIPTION/ORDERING INFORMATION

The TLVH431 devices are low-voltage 3-terminal adjustable voltage references, with thermal stability specified over the automotive temperature range. Output voltage can be set to any value between V_{REF} (1.24 V) and 18 V with two external resistors (see Figure 2). These devices operate from a lower voltage (1.24 V) than the widely used TL431 and TL1431 shunt-regulator references.

When used with an optocoupler, the TLVH431 devices are ideal voltage reference in isolated feedback circuits for 3-V to 3.3-V switching-mode power supplies. They have a typical output impedance of 0.25 Ω. Active output circuitry provides a very sharp turn-on characteristic, making the TLVH431 an excellent replacement for low-voltage Zener diodes in many applications, including on-board regulation and adjustable power supplies.

| T _A | V _{REF} TOLERANCE | PACKAG | iE ⁽²⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|----------------|-------------------------------|----------------|-------------------|-----------------------|------------------|--|
| | 0.5% | SOT-23-5 – DBV | Reel of 3000 | TLVH431BQDBVRQ1 | VOPQ | |
| -40°C to 125°C | 0.5% | SOT-23-3 - DBZ | Reel of 3000 | TLVH431BQDBZRQ1 | VPIQ | |
| | 1% | SOT-23-5 – DBV | Reel of 3000 | TLVH431AQDBVRQ1 | VOOQ | |

ORDERING INFORMATION⁽¹⁾

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI (1) web site at www.ti.com.

Package drawings, thermal data, and symbolization are available at www.ti.com/packaging. (2)



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EQUIVALENT SCHEMATIC





ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| V_{KA} | Cathode voltage ⁽²⁾ | 20 V |
|------------------|--|------------------|
| Ι _Κ | Cathode current range | –25 mA to 80 mA |
| I _{ref} | Reference current range | –0.05 mA to 3 mA |
| θ_{JA} | Package thermal impedance ⁽³⁾ (4) | 206°C/W |
| TJ | Operating virtual junction temperature | 150°C |
| T _{stg} | Storage temperature range | –65°C to 150°C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Voltage values are with respect to the anode terminal, unless otherwise noted.

(3) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

| | | MIN | MAX | UNIT |
|-----------------|--------------------------------|-----------|-----|------|
| V _{KA} | Cathode voltage | V_{REF} | 18 | V |
| Ι _Κ | Cathode current (continuous) | 0.1 | 70 | mA |
| T _A | Operating free-air temperature | -40 | 125 | °C |

STRUMENTS

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TLVH431A ELECTRICAL CHARACTERISTICS

at 25°C free-air temperature (unless otherwise noted)

| | PARAMETER | TEST CO | MIN | TYP | MAX | UNIT | |
|--|--|---|--|-------|------|-------|---|
| | | | $T_A = 25^{\circ}C$ | 1.228 | 1.24 | 1.252 | |
| V_{REF} | Reference voltage | $V_{KA} = V_{REF}$, $I_K = 10 \text{ mA}$ | $T_A = $ full range ⁽¹⁾ (see Figure 1) | 1.209 | | 1.271 | V |
| V _{REF(dev)} | V_{REF} deviation over full temperature range $^{(1)}$ $^{(2)}$ | $V_{KA} = V_{REF}$, $I_K = 10$ mA (s | | 11 | 31 | mV | |
| $\frac{\Delta V_{\text{REF}}}{\Delta V_{\text{KA}}}$ | Ratio of V _{REF} change to cathode voltage change | $V_{\rm K} = V_{\rm REF}$ to 18 V, $I_{\rm K} = 10$ | | -1.5 | -2.7 | mV/V | |
| I _{ref} | Reference terminal current | $I_{\rm K}$ = 10 mA, R1 = 10 kΩ, I | | 0.1 | 0.5 | μA | |
| I _{ref(dev)} | I _{ref} deviation over full temperature range ⁽¹⁾ ⁽²⁾ | $I_{\rm K} = 10$ mA, R1 = 10 kΩ, R | | 0.15 | 0.5 | μA | |
| I _{K(min)} | Minimum cathode current for regulation | $V_{KA} = V_{REF}$ (see Figure 1) | | 60 | 100 | μA | |
| I _{K(off)} | Off-state cathode current | $V_{REF} = 0$, $V_{KA} = 18$ V (see | | 0.02 | 0.1 | μA | |
| z _{KA} | Dynamic impedance ⁽³⁾ | $V_{KA} = V_{REF}$, f ≤ 1 kHz, I _K = 0.1 mA to 70 mA (see Figure 1) | | | 0.25 | 0.4 | Ω |

(1) Full temperature range is -40° C to 125° C.

 (2) The deviation parameters V_{REF(dev)} and I_{ref(dev)} are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage, αV_{REF}, is defined as:

$$|\alpha V_{\mathsf{REF}}| \left(\frac{\mathsf{ppm}}{\mathsf{o}\mathsf{C}}\right) = \frac{\left(\frac{V_{\mathsf{REF}}(\mathsf{dev})}{V_{\mathsf{REF}}(\mathsf{T}_{\mathsf{A}}=25^{\circ}\mathsf{C})}\right) \times 10^{6}}{\Delta \mathsf{T}_{\mathsf{A}}}$$

where ΔT_A is the rated operating free-air temperature range of the device. αV_{REF} can be positive or negative, depending on whether minimum V_{REF} or maximum V_{REF} , respectively, occurs at the lower temperature.

(3) The dynamic impedance is defined as:

$$z_{KA} = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is defined as: $|z_{KA}| = \frac{\Delta V}{\Delta I} \approx |z_{KA}| \times \left(1 + \frac{R1}{R2}\right)$

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TLVH431B ELECTRICAL CHARACTERISTICS

at 25°C free-air temperature (unless otherwise noted)

| | PARAMETER | TEST CO | MIN | TYP | MAX | UNIT | |
|--|--|---|--|-------|------|-------|---|
| | | | $T_A = 25^{\circ}C$ | 1.234 | 1.24 | 1.246 | |
| V _{REF} | Reference voltage | $V_{KA} = V_{REF}, I_K = 10 \text{ mA}$ | $T_A = full range^{(1)}$ (see Figure 1) | 1.221 | | 1.265 | V |
| V _{REF(dev)} | V_{REF} deviation over full temperature range $^{(1)}$ $^{(2)}$ | $V_{KA} = V_{REF}$, $I_K = 10$ mA (s | | 11 | 31 | mV | |
| $\frac{\Delta V_{\text{REF}}}{\Delta V_{\text{KA}}}$ | Ratio of V _{REF} change to cathode voltage change | $I_{\rm K}$ = 10 mA, $V_{\rm K}$ = $V_{\rm REF}$ to | | -1.5 | -2.7 | mV/V | |
| I _{ref} | Reference terminal current | I_{K} = 10 mA, R1 = 10 k Ω , F | | 0.1 | 0.5 | μA | |
| I _{ref(dev)} | I _{ref} deviation over full temperature range ⁽¹⁾ ⁽²⁾ | $I_{\rm K} = 10 \text{ mA}, \text{ R1} = 10 \text{ k}\Omega, \text{ F}$ | | 0.15 | 0.5 | μA | |
| I _{K(min)} | Minimum cathode current for regulation | $V_{KA} = V_{REF}$ (see Figure 1) | | 60 | 100 | μA | |
| I _{K(off)} | Off-state cathode current | $V_{REF} = 0$, $V_{KA} = 18$ V (see | | 0.02 | 0.1 | μA | |
| z _{KA} | Dynamic impedance ⁽³⁾ | $V_{KA} = V_{REF}$, f ≤ 1 kHz, I _K = 0.1 mA to 70 mA (see Figure 1) | | | 0.25 | 0.4 | Ω |

(1) Full temperature range is -40°C to 125°C.

(2) The deviation parameters V_{REF(dev)} and I_{ref(dev)} are defined as the differences between the maximum and minimum values obtained over the rated temperature range. The average full-range temperature coefficient of the reference input voltage, αV_{REF}, is defined as:

$$|\alpha V_{\mathsf{REF}}| \left(\frac{\mathsf{ppm}}{\mathsf{o}\mathsf{C}}\right) = \frac{\left(\frac{V_{\mathsf{REF}}(\mathsf{dev})}{V_{\mathsf{REF}}\left(\mathsf{T}_{\mathsf{A}} = 25^{\circ}\mathsf{C}\right)}\right) \times 10^{6}}{\Delta\mathsf{T}_{\mathsf{A}}}$$

where ΔT_A is the rated operating free-air temperature range of the device. αV_{REF} can be positive or negative, depending on whether minimum V_{REF} or maximum V_{REF} , respectively, occurs at the lower temperature.

(3) The dynamic impedance is defined as:

$$z_{KA} = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is defined as: $|z_{KA}| = \frac{\Delta V}{\Delta I} \approx |z_{KA}| \times (1 + \frac{R1}{R2})$

TEXAS INSTRUMENTS

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PARAMETER MEASUREMENT INFORMATION

Operation of the device at any conditions beyond those indicated under *recommended operating conditions* is not implied.



Figure 1. Test Circuit for $V_{KA} = V_{REF}$, $V_O = V_{KA} = V_{REF}$



Figure 2. Test Circuit for $V_{KA} > V_{REF}$, $V_O = V_{KA} = V_{REF} \times (1 + R1/R2) + I_{ref} \times R1$



Figure 3. Test Circuit for I_{K(off)}

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PARAMETER MEASUREMENT INFORMATION (continued)





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PARAMETER MEASUREMENT INFORMATION (continued)



Figure 9.

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PARAMETER MEASUREMENT INFORMATION (continued)



⁽¹⁾ Extrapolated from life-test data taken at 125°C; the activation energy assumed is 0.7 eV.







TEST CIRCUIT FOR EQUIVALENT INPUT NOISE VOLTAGE





PARAMETER MEASUREMENT INFORMATION (continued)



TEST CIRCUIT FOR 0.1-Hz TO 10-Hz EQUIVALENT NOISE VOLTAGE

Figure 12.

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PARAMETER MEASUREMENT INFORMATION (continued)





AND PHASE MARGIN







TEST CIRCUIT FOR REFERENCE IMPEDANCE





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PARAMETER MEASUREMENT INFORMATION (continued)





TEST CIRCUIT FOR PULSE RESPONSE 1







Figure 16.



PARAMETER MEASUREMENT INFORMATION (continued)



Figure 17. Phase Margin Test Circuit



Figure 18.









Capacitive Load - nF







Figure 21. Flyback With Isolation Using TLVH431 as Voltage Reference and Error Amplifier

Figure 21 shows the TLVH431 used in a 3.3-V isolated flyback supply. Output voltage V_O can be as low as reference voltage V_{REF} (1.24 V). The output of the regulator plus the forward voltage drop of the optocoupler LED (1.24 + 1.4 = 2.64 V) determine the minimum voltage that can be regulated in an isolated supply configuration. Regulated voltage as low as 2.7 Vdc is possible in the topology shown in Figure 21.



PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| TLVH431AQDBVRQ1 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TLVH431BQDBVRQ1 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TLVH431BQDBZRQ1 | ACTIVE | SOT-23 | DBZ | 3 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF TLVH431A-Q1, TLVH431B-Q1 :

• Catalog: TLVH431A, TLVH431B





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NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| , | *All dimensions are nominal | | | | | | | | | | | | |
|---|-----------------------------|--------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| | Device | | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| | TLVH431BQDBZRQ1 | SOT-23 | DBZ | 3 | 3000 | 179.0 | 8.4 | 3.15 | 2.95 | 1.22 | 4.0 | 8.0 | Q3 |

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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLVH431BQDBZRQ1 | SOT-23 | DBZ | 3 | 3000 | 203.0 | 203.0 | 35.0 |

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.

D. Falls within JEDEC MO-178 Variation AA.



DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.

- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



DBZ (R-PDSO-G3)

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

C. Lead dimensions are inclusive of plating.

D. Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.

E Falls within JEDEC TO-236 variation AB, except minimum foot length.





NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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